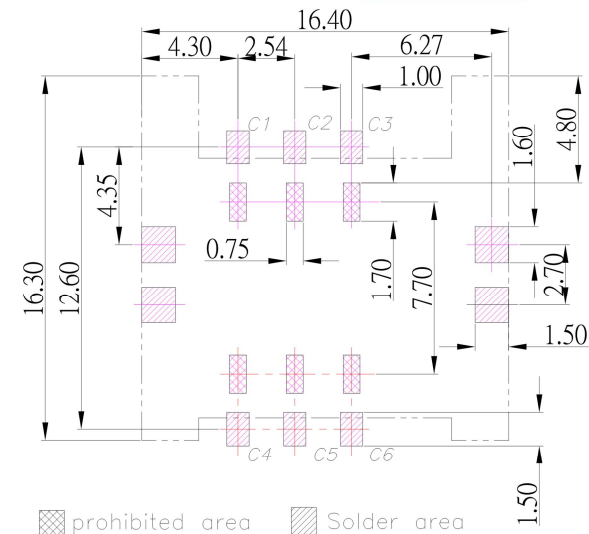
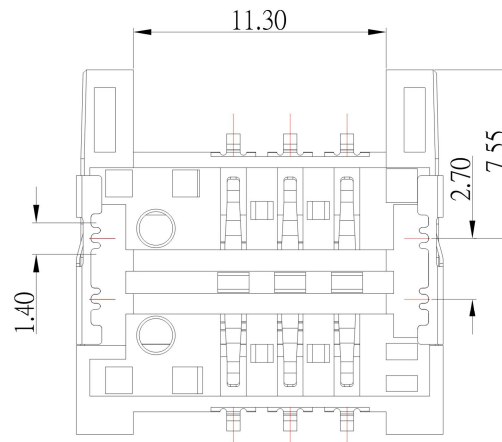
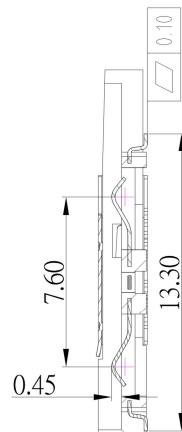
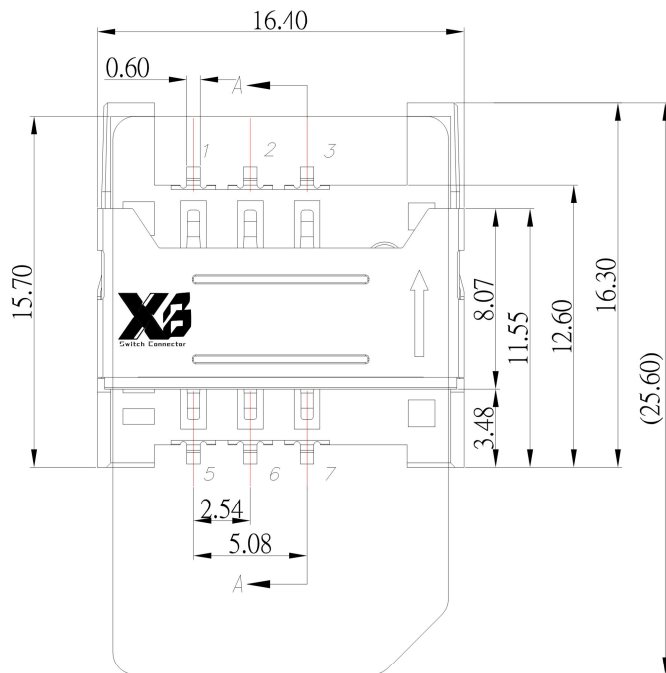




P.C.B LAYOUT
TOP VIEW

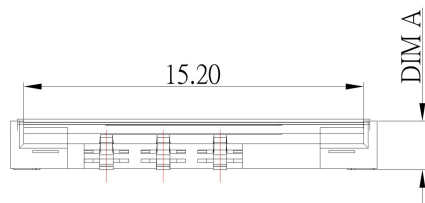
SPECIFICATION

Material :

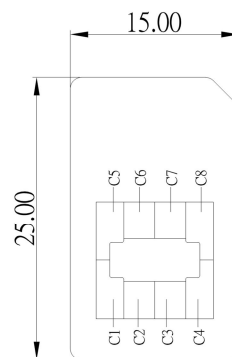
1. Housing: High-Thermoplastic, Black
2. Terminal: Copper Alloy
3. Shell: Copper Alloy

Finish:

- 1.Terminal: Plated Gold in Mating Area ;
Tin Plated on Solder Balls ;
Nickel under plated overall
- 2.Shell: Nickel under Plated surface layer



PIN NO	PIN NAME
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O



PART NO	DIM A
SIM-214H-18	1.8mm
SIM-214H-22	2.2mm



东莞市溪榜电子有限公司
DONG GUAN XI BANG ELECTRONICS CO., LTD.

TOLERANCE UNLESS
OTHERWISE STATED :

Up to 5 ±0.2
Above 5 ~ 15 ±0.3
Above 15 ~ 30 ±0.4
Above 30 ~ 50 ±0.5
Angle ±0.3°

3RD.
ANGEL'S



UNITS

MM

DRAWN BY: Jack Lu
CHECKED BY: Jacky Chen
APPROVED BY: Tony Kao

DATE: 09/25/18
DATE: 09/25/18
DATE: 09/25/18

MAT'L	FINISH	SCALE	SHEET NO.	TITLE	CONNECTOR	SIZE
		1 : 1	1 of 1	MODLE	SIM Card 側推	A4
				DWG NO.	SIM-214H-x-S267	VER
				PART NO.	SIM-214H-x-S267	R

ITEM NO. DESCRIPTION DRAWN DATE